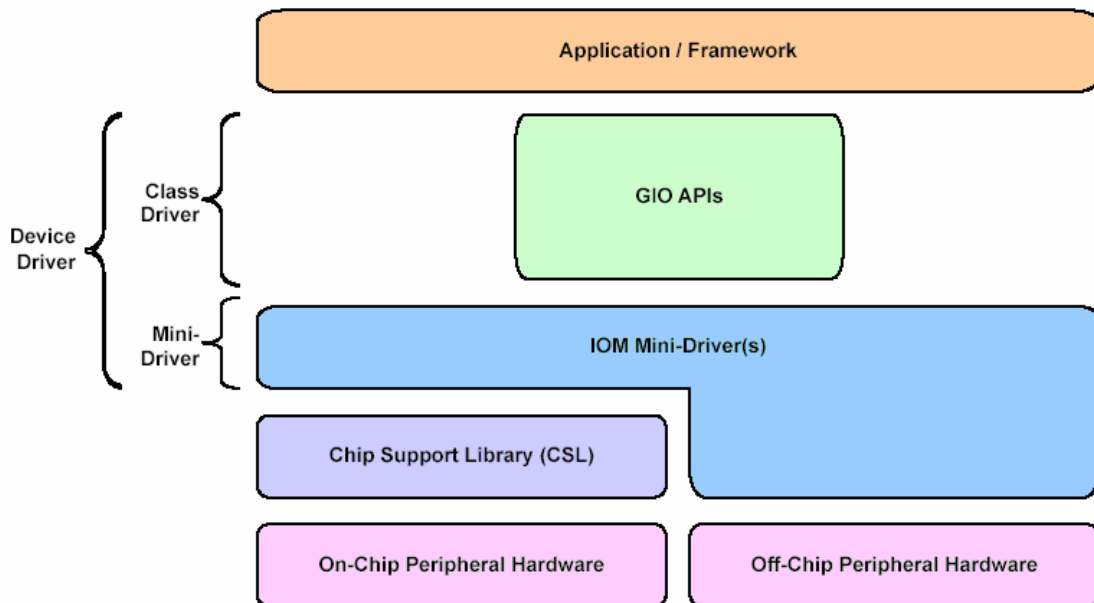




- Middle layer of the driver conforms to IO Mini driver model defined by the DSP/BIOS DDK (Device Driver Development Kit) Framework.
- Supports EDMA and interrupt modes of operation (Interrupt mode not tested)
- Supports receive and transmit in I2S mode and transmit in DIT mode



Description

- Details of tools used and versions are available in release notes

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Capabilities

The following table gives a quick overview of the supported API provided by the GIO layer to interact with the driver

GIO API called by application	mini-driver API called	Description
GIO_create (name, Int mode, Int *status, Ptr chanParams, GIO_Attrs *attrs);	static Int mcasep_mdCreateChan (Ptr *chanp, Ptr devp, String name, Int mode, Ptr chanParams, IOM_TiomCallback cbFxn, Ptr cbArg);	This assigns one of the device channels to be used for the operation (rcv/xmt). It hooks up the necessary ISRs and configures the associated eDMA channel.
GIO_Delete (GIO_Handle gioChan);	static Int mcasep_mdDeleteChan(Ptr chanp);	Frees up resources held by channel.
GIO_submit (gioChan, IOM_READ, bufp, psize, appCallback);	static Int mcasep_mdSubmitChan(Ptr chanp, IOM_Packet *packet);	Submits a read packet to configure the McASP receive section with.
GIO_submit (gioChan, IOM_WRITE, bufp, psize, appCallback);	static Int mcasep_mdSubmitChan(Ptr chanp, IOM_Packet *packet);	Submits a write packet to configure the McASP transmit section with.
GIO_Flush(gioChan);	static Int mcasep_mdControlChan(Ptr chanp, Uint16 cmd, Ptr args);	Drains all existing packets for this channel. This call also prevents stalls submission of packets to the channel
GIO_Abort(gioChan);	static Int mcasep_mdControlChan(Ptr chanp, Uint16 cmd, Ptr args);	This call aborts all packets submitted to the channel and places the corresponding state machine in reset.
GIO_Control(gioChan, cmd, args);	static Int mcasep_mdControlChan(Ptr chanp, Uint16 cmd, Ptr args);	This submits other control commands to the mini-driver.

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Driver Performance Characteristics

Release Mode:

MCASP DEVICE DRIVER SUB-COMPONENT	PROGRAM MEMORY (IN BYTES)	DATA MEMORY (IN BYTES)		
		MEMORY TYPE		TOTAL
		INITIALIZED	UN INITIALIZED	
dda	2284	40	156	2480
ddc	24212	152	4232	28596
llc	9500	0	660	9500
Total	35996	192	4388	40576

- System Components Total Memory (Code & Data): **40576** Bytes

Note: The Driver Performance Characteristics can be included once testing is done on DM648/C6452 SOC.

Driver Profiling Characteristics

SIO						
API Profiled	Trial-1	Trial-2	Trial-3	Average (usecs)	Maximum (usecs)	Minimum (usecs)
SIO_create - Tx	2301263	2301263	2301260	2301262	2301263	2301260
SIO_create - Rx	57	56	57	57	57	56
SIO_Submit - Write	1	1	1	1	1	1
SIO_Submit- Read	1	1	1	1	1	1
SIO_Delete - Tx	20	20	20	20	20	20
SIO_Delete- Rx	39	39	39	39	39	39

Note: Due to the initialization of codec related steps GIO_create - Tx is taking extremely large time.

GIO						
API Profiled	Trial-1	Trial-2	Trial-3	Average (usecs)	Maximum (usecs)	Minimum (usecs)
GIO_create - Tx	2301265	2301265	2301264	2301265	2301265	2301264
GIO_create - Rx	55	55	55	55	55	55
GIO_Submit - Write	23	22	22	22	22	22
GIO_Submit- Read	14	13	13	13	14	13
GIO_Delete - Tx	20	30	29	26	30	20
GIO_Delete- Rx	38	82	84	68	84	38

Note: Due to the initialization of codec related steps GIO_create - Tx is taking extremely large time.

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Driver Performance Characteristics

AUDIO_WRITE

Test Setup Information	Sampling Rate in Hz	Word Length in bits	No. of channels/sample	DMA Mode		
				No. of bytes/Sec	Buffer Size in Bytes	Duration in Sec
ARM Frequency = 26 MHZ	8000	32	1	32931	15360	50
	12600	32	1	51916	15360	50
	44100	32	1	179896	15360	50
	48000	32	1	195788	15360	50
	96000	32	1	391230	15360	50

AUDIO_READ

Test Setup Information	Sampling Rate in Hz	Word Length in bits	No. of channels/sample	DMA Mode		
				No. of bytes/Sec	Buffer Size in KB	Duration in Sec
ARM Frequency = 26 MHZ	8000	32	1	32931	15360	50
	12600	32	1	51609	15360	50
	44100	32	1	179180	15360	50
	48000	32	1	195779	15360	50
	96000	32	1	391249	15360	50

References

- [1] DSP/BIOS Driver Developer's guide
- [2] McASP Programmer's Reference Guide

Glossary

IOM	TI Terminology, Input/Output Mini Driver.
DDC	TI Terminology, Device Driver Core that is OS independent
CSL	Chip Support Library
GIO	Generic I/O Module
McASP	Multi-channel Audio Serial Port
I2S	Inter-Integrated Sound protocol
DIT	Digital Audio Interface Transmission
IOM	Input/Output Module
EDMA	Enhanced Direct Memory Access

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